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BY: *Madge M. Morales*

Date: June 2, 2005

MAIL STOP AMENDMENT

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Patent Application of:

Yuan-Chang Huang

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:

Conf. No.: 8636

: Group Art Unit:

2811

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Appln. No.: 10/717,355

: Examiner:

Hung K. Vu

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Filing Date: November 19, 2003

: Attorney Docket No.: 681954-65US

(P03920003US)

Title: CONDUCTIVE BUMPS WITH INSULATING SIDEWALLS (as amended)

**AMENDMENT**

This Amendment is being filed in response to the Office Action dated December 2, 2005 and is being filed within the third month after the shortened statutory period set for a response to the Office Action. A Petition for a three month extension of time accompanies this paper. If any additional fees are due, charge the fees to Deposit Account No. 50-1017 (Billing No. 681954.0065).

**Amendments to the Title** begin on page 2 of this paper.

**Amendments to the Claims** begin on page 3 of this paper.

**Amendments to the Abstract** begin on page 6 of this paper.

**Remarks and Conclusion** begin on page 7 of this paper.

Application No. 10/717,355  
Reply to Office Action of December 2, 2004

**Amendments to the Title:**

On page 1, delete the original Title in its entirety and replace it with the following new Title:

Conductive Bumps Formed as Unitary Structures with Insulating Sidewalls and Directly Exposed Top Surfaces